Introduction

This application note describes the standby function (HALT mode, STOP mode and SNOOZE mode) of the RL78/F23 and the RL78/F24 microcontrollers by providing examples for setting each of the modes. For the clocks and each peripheral function described in this document, refer to the applicable User’s Manual: Hardware.

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1. HALT Mode

In HALT mode, power consumption is reduced by stopping the supply of the operation clock to the CPU. The CPU transitions to the HALT mode when the HALT instruction is executed. Even after the HALT instruction is executed, the state of each clock remains unchanged from the previous state. Table 1-1 shows the clock states in HALT mode.

The HALT mode is released when a source for the enabled interrupt (the value of the interrupt mask flag is 0) is generated. Figure 1-1 illustrates transition/release timing of HALT mode.

The processing after release of HALT mode varies depending on whether the interrupt request acknowledgement is enabled (EI) or disabled (DI). When the MCU transitions to HALT mode while the interrupt request acknowledgement is enabled (EI), the vectored-interrupt service will start after release of HALT mode. Meanwhile, when the MCU transitions to HALT mode while the interrupt request acknowledgement is disabled (DI), the instruction at the next address after the HALT instruction is executed after release of HALT mode. Table 1-2 lists the peripheral function interrupts that can be used to release HALT mode.

Also, when the Flash memory CRC operation function (high-speed CRC) is completed, HALT mode will be released. Regarding the Flash memory CRC operation function, refer to the application note “Safety Function (R01AN6624)”.

Table 1-1. Clock States in HALT Mode

<table>
<thead>
<tr>
<th>Clock</th>
<th>Before transition to HALT mode</th>
<th>In HALT mode</th>
<th>After HALT mode released</th>
</tr>
</thead>
<tbody>
<tr>
<td>Clock supply to CPU</td>
<td>Not stopped</td>
<td>Stops</td>
<td>Not Stopped</td>
</tr>
<tr>
<td>High-speed system clock</td>
<td>Oscillating or stops</td>
<td>Remains unchanged from the previous state</td>
<td>Remains unchanged from the previous state</td>
</tr>
<tr>
<td>High-speed on-chip oscillator clock</td>
<td>Oscillating or stops</td>
<td>Remains unchanged from the previous state</td>
<td>Remains unchanged from the previous state</td>
</tr>
<tr>
<td>PLL clock</td>
<td>Oscillating or stops</td>
<td>Remains unchanged from the previous state</td>
<td>Remains unchanged from the previous state</td>
</tr>
<tr>
<td>Low-speed on-chip oscillator clock</td>
<td>Oscillating or stops</td>
<td>Remains unchanged from the previous state</td>
<td>Remains unchanged from the previous state</td>
</tr>
<tr>
<td>Subsystem clock</td>
<td>Oscillating or stops</td>
<td>Remains unchanged from the previous state</td>
<td>Remains unchanged from the previous state</td>
</tr>
<tr>
<td>Watchdog timer-dedicated low-speed on-chip oscillator</td>
<td>Oscillating or stops</td>
<td>Remains unchanged from the previous state or stops(^\text{Note})</td>
<td>State before transition to HALT mode</td>
</tr>
</tbody>
</table>

Note: This varies depending on the settings of the WDTON bit and the WDSTBYON bit in the user option bytes (000C0H/040C0H).

- When WDTON=1 and WDSTBYON=1: Continues oscillating.
- When WDTON=1 and WDSTBYON=0: Stops oscillating. The counter is cleared after HALT mode is released and the clock oscillation starts.

![Figure 1-1. Transition/Release Timing of HALT Mode](image-url)
Table 1-2. Peripheral Function used to Release HALT Mode

<table>
<thead>
<tr>
<th>CPU's operation clock when the HALT instruction is executed</th>
<th>Peripheral function interrupts used to release HALT mode&lt;sup&gt;Note 1&lt;/sup&gt;</th>
</tr>
</thead>
</table>
| Main system clock (High-speed system clock or high-speed on-chip oscillator clock) | • Timer array unit  
• Real-time clock  
• Clock monitor  
• Timer RJ  
• Timer RDe  
• A/D converter  
• Comparator  
• Serial array unit  
• Serial interface (IICA)  
• LIN/UART module (RLIN3)  
• CANFD interface  
• DTC  
• Voltage detection function  
• External interrupt  
• Key interrupt  
• Watchdog timer<sup>Note 2</sup> |

| Subsystem/Low-speed on-chip oscillator clock | • Timer array unit  
• Real-time clock  
• Timer RJ  
• Timer RDe  
• Serial array unit  
• DTC  
• Voltage detection function  
• External interrupt  
• Key interrupt  
• Watchdog timer<sup>Note 2</sup> |

Notes:  
1. The peripheral function interrupts vary depending on the product used. For details, refer to the User's Manual: Hardware of the product used.  
2. This varies depending on the settings of the WDTON bit and the WDSTBYON bit in the user option byte (000C0H/040C0H).  
   When WDTON=1 and WDSTBYON=1: Continues oscillating.  
   When WDTON=1 and WDSTBYON=0: Stops oscillating. The counter is cleared after HALT mode is released and the clock oscillation starts.
1.1 Procedure for HALT Mode Setting

Figure 1-2 shows an example for HALT mode setting.

- **START**
  - Disable interrupts

- **HALT instruction**
  - 
    - *Stop the function that are not used in HALT mode.*
      - (Set the bits in PERx register of the unused functions to 0. Also, set the unused interrupt mask flag to 1.)
    - *Set the function to be used to release HALT mode and enable the interrupts.*
      - (Set the interrupt mask flag of the function to be used to 0. Also, set the interrupt request flag of the function to be used to 0.)
    - *Stop the clocks that are not used in HALT mode.*
      - (Stop the unused peripheral functions/clocks to reduce power consumption.)

- **END**
  - Enable the interrupts

**Remarks:** In this example, the HALT instruction is executed: when the timer array unit (INTTM00) and the external interrupt (INTP0) are used to release HALT mode and also the interrupt request acknowledgment is disabled.

**Diagram:**
- **Normal Operation**
  - Processing before transition to HALT mode
  - HALT instruction
  - Interrupt request (INTTM00)?
    - No (TMIF00=0)
      - INTTM00 processing
    - Yes (TMIF00=1)
      - No (PIF0=0)
        - INTP0 processing
      - Yes (PIF0=1)
        - HALT release processing

**Remarks:**
- **TMIF00**: A bit in the interrupt request flag register (IF1L)
- **PIF0**: A bit in the interrupt request flag register (IF0L)

**Figure 1-2. Example for HALT Mode Setting**
1.2 Notes on HALT Mode

- When the value of the interrupt mask flag is 0 (interrupt servicing is enabled) and also when the value of the interrupt request flag is 1 (an interrupt request signal is generated), HALT mode will be released immediately even when the HALT instruction is executed.

- The processing after the release of HALT mode varies depending on whether the interrupt request acknowledgement is enabled (EI) or disabled (DI). When the MCU transitions to HALT mode while the interrupt request acknowledgement is enabled (EI), the vectored-interrupt servicing will start when an interrupt request (interrupt servicing is enabled) is generated while the value of the interrupt mask flag is 0. When the MCU transitions to HALT mode when the interrupt request acknowledgement is disabled (DI), the instruction at the next address after the HALT instruction will be executed when an interrupt request is generated.

- HALT mode is released when a reset signal is generated.

- Whether to make the watchdog timer-dedicated low-speed on-chip oscillator continue oscillating or stop oscillating in HALT mode is selected by setting the user option byte (000C0H/040C0H).
2. STOP Mode

In STOP mode, power consumption is reduced by stopping the main system clock (high-speed system clock, high-speed on-chip oscillator clock). The CPU transitions to STOP mode when the STOP instruction is executed. Table 2-1 shows the clock states in STOP mode.

STOP mode is released when a source for the enabled interrupt (the mask flag of the interrupt enabled is set to 0) is generated. Figure 2-1 illustrates transition/release timing of STOP mode.

The processing after the release of STOP mode varies depending on whether the interrupt request acknowledgement is enabled (EI) or disabled (DI). When the MCU transitions to STOP mode while the interrupt request acknowledgement is enabled (EI), the vectored-interrupt service will start after release of STOP mode. When the MCU transitions to STOP mode while the interrupt request acknowledgement is disabled (DI), the instruction at the next address after the STOP instruction is executed after release of STOP mode. Table 2-2 shows the peripheral function interrupts that can be used to release STOP mode.

<table>
<thead>
<tr>
<th>Table 2-1. Clock States in STOP Mode</th>
</tr>
</thead>
<tbody>
<tr>
<td>Clock</td>
</tr>
<tr>
<td>-------</td>
</tr>
<tr>
<td>Clock supply to CPU</td>
</tr>
<tr>
<td>High-speed system clock</td>
</tr>
<tr>
<td>High-speed on-chip oscillator clock</td>
</tr>
<tr>
<td>PLL clock Note 2</td>
</tr>
<tr>
<td>Low-speed on-chip oscillator clock</td>
</tr>
<tr>
<td>Subsystem clock</td>
</tr>
<tr>
<td>Watchdog timer-dedicated low-speed on-chip oscillator</td>
</tr>
</tbody>
</table>

Notes:
1. Be sure to execute the transition to STOP mode when the CPU clock is the main system clock (high-speed system clock or high-speed on-chip oscillator clock).
2. To make the CPU transition to STOP mode, set the PLLON bit to 0 (PLL stopped) beforehand.
3. This varies depending on the settings of the WDTON bit and the WDSTBYON bit in the user option byte (000C0H/040C0H).
   - When WDTON=1 and WDSTBYON=1: Continues oscillating.
   - When WDTON=1 and WDSTBYON=0: Stops oscillating. The counter is cleared after STOP mode is released and the clock oscillation starts.

![Figure 2-1. Transition/Release Timing of STOP Mode](image-url)
Table 2-2. Peripheral Function Interrupts used to Release STOP Mode

<table>
<thead>
<tr>
<th>CPU’s operation clock when STOP instruction is executed</th>
<th>Peripheral function interrupts used to release STOP mode&lt;sup&gt;Note 1&lt;/sup&gt;</th>
</tr>
</thead>
<tbody>
<tr>
<td>Main system clock (High-speed system clock or high-speed on-chip oscillator clock)</td>
<td>• Real-time clock&lt;sup&gt;Note 2&lt;/sup&gt;</td>
</tr>
<tr>
<td></td>
<td>• Timer RJ&lt;sup&gt;Note 2&lt;/sup&gt;</td>
</tr>
<tr>
<td></td>
<td>• Timer RDe&lt;sup&gt;Note 2&lt;/sup&gt;</td>
</tr>
<tr>
<td></td>
<td>• Comparator</td>
</tr>
<tr>
<td></td>
<td>• Serial interface (IICA)&lt;sup&gt;Note 3&lt;/sup&gt;</td>
</tr>
<tr>
<td></td>
<td>• Voltage detection function</td>
</tr>
<tr>
<td></td>
<td>• External interrupt</td>
</tr>
<tr>
<td></td>
<td>• Key interrupt</td>
</tr>
<tr>
<td></td>
<td>• Watchdog timer&lt;sup&gt;Note 4&lt;/sup&gt;</td>
</tr>
</tbody>
</table>

Notes: 1. The peripheral function interrupts vary depending on the product used. For details, refer to the User’s Manual: Hardware of the product used.
2. This can be used when the subsystem clock that continues oscillating in STOP mode is selected as the operation clock.
3. This can be used when an extension code from the master device or a local address has been received in STOP mode.
4. This varies depending on the settings of the WDTON bit and the WDSTBYON bit in the user option byte (00C0H/040C0H).
   - When WDTON=1 and WDSTBYON=1: Continues oscillating.
   - When WDTON=1 and WDSTBYON=0: Stops oscillating. The counter is cleared after STOP mode is released and the clock oscillation starts.
2.1 Procedure for STOP Mode Setting

Figure 2-2 shows an example for STOP mode setting.

- **START**
  - Disable interrupt

**Normal Operation**

- **Processing before transition to STOP mode**
  - **STOP instruction**
  - **Interrupt request (INTTRJ0)?**
    - Yes (TRJIF0=1)
      - **INTTRJ0 processing**
    - No (TRJIF0=0)

**STOP mode**

- **Interrupt request (INTLIN0WUP)?**
  - Yes (LIN0WUPIF=1)
    - **INTLIN0WUP processing**
  - No (LIN0WUPIF=0)

- **STOP release processing**

**Normal Operation**

- **Enable the interrupts**
  - **END**

Remarks: In this example, the STOP instruction is executed: when the high-speed on-chip oscillator is selected as the CPU clock and the timer RJ (INTTRJ0) and RLIN3 (INTLIN0WUP) are used to release STOP mode while the interrupt request Acknowledgement is disabled.

**TRJIF0**: A bit in the interrupt request flag register (IF0H)
**LIN0WUPIF**: A bit in the interrupt request flag register (IF2L)

Figure 2-2. Example for STOP Mode Setting
2.2 Notes on STOP Mode

- The CPU can transition to STOP mode only when the CPU clock is the main system clock. Therefore, do not make the CPU transition to STOP mode when the CPU operates on the PLL clock, or the subsystem/low-speed on-chip oscillator clock.

- To make the CPU transition to STOP mode when the CPU clock is the high-speed system clock (X1 oscillator), the settings of the OSTS register need to be completed before executing the STOP instruction.

- Before executing the STOP instruction, be sure to stop the operation of the peripheral hardware (excluding the function(s) operating in SNOOZE mode) running on the main system clock (high-speed system clock or highspeed on-chip oscillator clock).

- When the value of the interrupt mask flag is 0 (interrupt servicing is enabled) and also when the value of the interrupt request flag is 1 (an interrupt request signal is generated), STOP mode will be released immediately even when the STOP instruction is executed.

- The processing after release of STOP mode varies depending on whether the interrupt request acknowledgement is enabled (EI) or disabled (DI). When the MCU transitions to STOP mode while the interrupt request acknowledgement is enabled (EI), the vectored-interrupt servicing will start when an interrupt request is generated while the value of the interrupt mask flag is 0 (interrupt servicing is enabled). When the MCU transitions to STOP mode while the interrupt request acknowledgement is disabled (DI), the instruction at the next address after the STOP instruction is executed when an interrupt request is generated.

- STOP mode is released when a reset signal is generated.

- Whether to make the watchdog timer-dedicated low-speed on-chip oscillator continue oscillating or stop oscillating in STOP mode is selected by setting the user option byte (000C0H/040C0H).
3. SNOOZE Mode

In SNOOZE mode, data reception by the LIN/UART module (RLIN3) and memory transfer by the DTC function are performed while the CPU operation is stopped. When a start trigger for the peripheral function is generated in STOP mode, the high-speed on-chip oscillator starts oscillating and the CPU transitions to SNOOZE mode. SNOOZE mode is released when an interrupt request for a peripheral function operating in SNOOZE mode is generated. Otherwise, if the interrupt request of the peripheral function is not generated, the MCU returns to STOP mode. Figure 3-1 illustrates transition/release timing of SNOOZE mode. Table 3-1 shows the clock states in SNOOZE mode.

Also, the RL78/F23 and RL78/F24 MCUs are provided with a function to output the SNOOZE status at transition to SNOOZE mode and when the SNOOZE mode is released. The settings of each function (data reception, DTC function and SNOOZE status output) in SNOOZE mode are described through examples in “3.1 Procedure for SNOOZE Mode Setting”.

![Figure 3-1. SNOOZE Mode Transition/Release Timing](image-url)
## Table 3-1. Clock States in SNOOZE Mode

<table>
<thead>
<tr>
<th>Clock</th>
<th>Normal operation mode (before transition to STOP mode)</th>
<th>In STOP mode&lt;sup&gt;Note 1&lt;/sup&gt;</th>
<th>In SNOOZE mode</th>
<th>Normal operation mode (after release of SNOOZE mode)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Clock supply to CPU</td>
<td>Not stopped</td>
<td>Stops</td>
<td></td>
<td>Not stopped</td>
</tr>
<tr>
<td>High-speed system clock</td>
<td>Oscillating or stops</td>
<td>Stops</td>
<td></td>
<td>Stops</td>
</tr>
<tr>
<td>High-speed on-chip oscillator clock</td>
<td>Oscillating</td>
<td>Stops</td>
<td></td>
<td>Oscillating</td>
</tr>
<tr>
<td>PLL clock&lt;sup&gt;Note 2&lt;/sup&gt;</td>
<td>Stops</td>
<td>Remains unchanged from the previous state</td>
<td></td>
<td>Remains unchanged from the previous state</td>
</tr>
<tr>
<td>Low-speed on-chip oscillator clock</td>
<td>Oscillating or stops</td>
<td>Remains unchanged from the previous state</td>
<td></td>
<td>Remains unchanged from the previous state</td>
</tr>
<tr>
<td>Subsystem clock</td>
<td>Oscillating or stops</td>
<td>Remains unchanged from the previous state</td>
<td></td>
<td>Remains unchanged from the previous state</td>
</tr>
<tr>
<td>Watchdog timer-dedicated low-speed on-chip oscillator clock</td>
<td>Oscillating or stops</td>
<td>Remains unchanged from the previous state or stops&lt;sup&gt;Note 3&lt;/sup&gt;</td>
<td>Remains unchanged from the previous state or stops&lt;sup&gt;Note 3&lt;/sup&gt;</td>
<td>State before transition to STOP mode</td>
</tr>
</tbody>
</table>

**Notes:**
1. Be sure to execute the transition to STOP mode when the CPU clock is the main system clock (high-speed system clock or high-speed on-chip oscillator clock).
2. To make the CPU transition to STOP mode, set the PLLON bit to 0 (PLL stopped) beforehand.
3. This varies depending on the settings of the WDTON bit and the WDSTBYON bit in the user option byte (000C0H/040C0H).
   - When WDTON=1 and WDSTBYON=1: Continues oscillating.
   - When WDTON=1 and WDSTBYON=0: Stops oscillating. The counter is cleared after transition to normal operation mode, and the clock oscillation starts.

The following peripheral functions can be used in SNOOZE mode.

- Real-time clock<sup>Note 1</sup>
- Timer RJ<sup>Note 1</sup>
- Timer RDe<sup>Note 1</sup>
- Clock output/buzzer output<sup>Note 1</sup>
- Comparator
- Serial interface (IICA)<sup>Note 2</sup>
- LIN/UART module (UART mode of RLIN3)<sup>Note 3</sup>
- Voltage detection function
- External interrupt
- Key interrupt
- Watchdog timer<sup>Note 4</sup>
- DTC

**Notes:**
1. These functions can be used when the subsystem clock that continues oscillating in STOP mode is selected as the operation clock.
2. This can be used when an extension code from the master device or a local address has been received in STOP mode.
3. Operates on the high-speed on-chip oscillator as the clock source in SNOOZE mode. This can be used as a factor for recovering from SNOOZE mode when the interrupt conditions are satisfied.
4. This varies depending on the settings of the WDTON bit and the WDSTBYON bit in the user option byte (000C0H/040C0H).
   - When WDTON=1 and WDSTBYON=1: Continues oscillating.
   - When WDTON=1 and WDSTBYON=0: Stops oscillating. The counter is cleared after the CPU returns to the normal operation mode.
3.1 Procedure for SNOOZE Mode Setting

3.1.1 Example of LIN/UART Module (RLIN3) Setting

Figure 3-2 is an example of setting the LIN/UART module (UART mode) to be used in SNOOZE mode. Figure 3-3 is a timing chart.

In this example below, the LIN/UART module (RLIN3) starts UART reception when the UART function of the LIN/UART module detects an edge (start bit) of LRXD0. When the data reception is completed, the data received by UART is compared with the data that has been set (the data is set in the LIDB0 register before the MCU transitions to STOP/SNOOZE mode). When the data matches, an interrupt is generated and SNOOZE mode is released.

**Remarks:** In this example, the LIN0 reception end interrupt request is used to release STOP/SNOOZE mode. The STOP instruction is executed while the interrupt request acknowledgement is disabled. Also, after the start bit in LRXD0 is detected, the MCU transitions to SNOOZE mode and UART reception starts. After UART reception is completed, LIDB0 (in this example, this is set to 55H) is compared with the received data. When both data match, the LIN0 reception end interrupt is generated and STOP/SNOOZE mode is released. When both data do not match, the MCU transitions STOP mode again.

\( f_{\text{SI}} \): High-speed on-chip oscillator clock frequency

**Figure 3-2. Example for SNOOZE Mode Setting (LIN/UART)**
**Operation mode**

<table>
<thead>
<tr>
<th>Normal operation</th>
<th>STOP</th>
<th>SNOOZE</th>
<th>STOP</th>
<th>SNOOZE</th>
<th>W1 Normal operation</th>
</tr>
</thead>
<tbody>
<tr>
<td>fIH</td>
<td>Oscillating</td>
<td>Stops</td>
<td>Oscillating</td>
<td>Stops</td>
<td>Oscillating</td>
</tr>
</tbody>
</table>

**LIN/UART (UART mode)**

<table>
<thead>
<tr>
<th>LRXD0 pin</th>
<th>ST</th>
<th>Received data (== 55H)</th>
<th>SP</th>
<th>ST</th>
<th>Received data (== 55H)</th>
<th>SP</th>
</tr>
</thead>
<tbody>
<tr>
<td>LURDR0</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>LIDB0</td>
<td>55H</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Standby release signal</td>
<td>INTLIN0RVC has not been occurred</td>
<td>INTLIN0RVC is occurred</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>INTRDR0</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>LST0.URS</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

- **<1>** Set the LIN/UART module (UART mode), etc. which need to be set before transition to STOP/SNOOZE mode.
- **<2>** The STOP instruction is executed and then CPU transitions to STOP mode. The oscillation of fIH stops.
- **<3>** When an input signal to the LRXD0 pin is detected, the CPU transitions to SNOOZE mode. The oscillation of fIH starts and UART reception starts.
- **<4>** When the UART reception is completed, the received data is compared with the value set in LIDB0. When they do not match, the MCU transitions to STOP mode again.
- **<5>** When the UART reception is completed, the received data is compared with the value set in LIDB0. When they match, INTLIN0RVC is generated and the MCU transitions to normal operation mode.
- **<6>** Set the LCUC0.OM0 bit to 0. Then, after the value of the LMST0.OMM0 bit changes to 0, set the LUSC0.UWC bit to 0.

**Remarks:**
- **LST0.URS**: Reception status
- **W1**: Time taken to transition to SNOOZE mode from STOP mode
- **W2**: Time taken to normal operation mode from SNOOZE mode
- **fIH**: High-speed on-chip oscillator frequency

---

**Figure 3-3. Timing Chart of SNOOZE Mode (LIN/UART)**
Table 3-2 is an example of settings for communication speed that are available in SNOOZE mode.

<table>
<thead>
<tr>
<th>Format</th>
<th>Baud rate</th>
<th>LIN clock source</th>
<th>LWBRn</th>
<th>LBRPn</th>
<th>Maximum Allowable Value</th>
<th>Minimum Allowable Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>1ST-8DATA-1PRY-1SP</td>
<td>1200bps</td>
<td>40 MHz ± 2.0%</td>
<td>001B</td>
<td>0000B</td>
<td>1038</td>
<td>2.66%</td>
</tr>
<tr>
<td></td>
<td>2400bps</td>
<td></td>
<td></td>
<td></td>
<td>517</td>
<td>2.50%</td>
</tr>
<tr>
<td></td>
<td>4800bps</td>
<td></td>
<td></td>
<td></td>
<td>256</td>
<td>1.97%</td>
</tr>
<tr>
<td></td>
<td>9600bps</td>
<td></td>
<td></td>
<td></td>
<td>126</td>
<td>1.30%</td>
</tr>
<tr>
<td></td>
<td>1200bps</td>
<td>32 MHz ± 2.0%</td>
<td>001B</td>
<td>0000B</td>
<td>830</td>
<td>2.64%</td>
</tr>
<tr>
<td></td>
<td>2400bps</td>
<td></td>
<td></td>
<td></td>
<td>413</td>
<td>2.40%</td>
</tr>
<tr>
<td></td>
<td>4800bps</td>
<td></td>
<td></td>
<td></td>
<td>205</td>
<td>2.16%</td>
</tr>
<tr>
<td></td>
<td>9600bps</td>
<td></td>
<td></td>
<td></td>
<td>101</td>
<td>1.68%</td>
</tr>
<tr>
<td></td>
<td>1200bps</td>
<td>40 MHz ± 2.2%</td>
<td>001B</td>
<td>0000B</td>
<td>1038</td>
<td>2.47%</td>
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<td>2400bps</td>
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<td></td>
<td></td>
<td>517</td>
<td>2.31%</td>
</tr>
<tr>
<td></td>
<td>4800bps</td>
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<td></td>
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<td>256</td>
<td>1.78%</td>
</tr>
<tr>
<td></td>
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<tr>
<td></td>
<td>1200bps</td>
<td>32 MHz ± 2.2%</td>
<td>001B</td>
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<td>830</td>
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<td>0000B</td>
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<td></td>
<td>516</td>
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</tr>
<tr>
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<td></td>
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<td>256</td>
<td>2.52%</td>
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<td>126</td>
<td>1.90%</td>
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<tr>
<td></td>
<td>1200bps</td>
<td>32 MHz ± 2.0%</td>
<td>001B</td>
<td>0000B</td>
<td>830</td>
<td>3.15%</td>
</tr>
<tr>
<td></td>
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<td>1.33%</td>
</tr>
<tr>
<td></td>
<td>1200bps</td>
<td>40 MHz ± 2.2%</td>
<td>001B</td>
<td>0000B</td>
<td>1037</td>
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<td></td>
<td>100</td>
<td>1.15%</td>
</tr>
</tbody>
</table>
### 3.1.2 Example of DTC Setting

Figure 3-4 is an example of setting the DTC transfer to be used in SNOOZE mode. Figure 3-5 is a timing chart.

In this example below, DTC transfer is performed by using the timer RJ0 as a DTC activation source, which allows P140 to perform inverted output. The MCU transitions to normal operation mode from SNOOZE mode when the INTP0 interrupt is generated.

![Diagram of DTC Setting Example](image)

**Figure 3-4. Example for SNOOZE Mode Setting (DTC)**

#### Remarks:
- In this example, DTC transfer is performed in SNOOZE mode. The STOP instruction is executed while the interrupt request acknowledgement is disabled, and the MCU transitions to SNOOZE mode when a source for the timer RJ0 interrupt is generated. Then DTC transfer is performed. When the DTC transfer is completed, the MCU transitions to STOP mode again. When the INTP0 interrupt is generated, the MCU returns to normal operation mode.

- **PIF0**: A bit in the interrupt request flag register (IFLR).
- **f_h**: High-speed on-chip oscillator clock frequency
- **f_l**: Low-speed on-chip oscillator frequency
Figure 3-5. Timing Chart of SNOOZE Mode (DTC)

### Table: Oscillating fIL and fIH

<table>
<thead>
<tr>
<th>Operation Mode</th>
<th>Normal Operation</th>
<th>STOP</th>
<th>W1</th>
<th>SZ</th>
<th>STOP</th>
<th>W1</th>
<th>SZ</th>
<th>STOP</th>
<th>WS</th>
<th>Normal Operation</th>
</tr>
</thead>
<tbody>
<tr>
<td>Oscillating</td>
<td>Oscillating</td>
<td>Stops</td>
<td>Oscillating</td>
<td>Oscillating</td>
<td>Oscillating</td>
<td>Oscillating</td>
<td>Oscillating</td>
<td>Oscillating</td>
<td>Oscillating</td>
<td>Oscillating</td>
</tr>
</tbody>
</table>

### Timer RJ

1. **Set the DTC, etc. that needs to be set before transition to STOP/SNOOZE mode.**
2. **Timer RJ starts counting.**
3. **The STOP instruction is executed and the CPU transition to STOP mode. The oscillation of fIL continues, but the oscillation of fIH stops.**
4. **Upon generation of the DTC activation source (INTTRJ0), the MCU transitions to SNOOZE mode. The oscillation of fIH starts, and DTC transfer starts after the wait time has elapsed.**
5. **DTC transfer allows P140 to perform inverted output. After the DTC transfer is completed, the MCU returns to STOP mode.**
6. **The MCU transitions to normal operation mode when a rising edge of INTP0 is detected.**

### Remarks:
- **W1**: Time taken to transition from STOP mode to SNOOZE mode
- **WS**: Time taken to transition from STOP mode to normal operation mode
- **SZ**: SNOOZE mode
- **fIH**: High-speed on-chip oscillator frequency
- **fIL**: Low-speed on-chip oscillator frequency
3.1.3 Example of SNOOZE Status Output

The SNOOZE status output function outputs the state of SNOOZE mode to SNZOUTi (i=0 to 7) pin. Figure 3-6 shows a block diagram of SNOOZE status output, Figure 3-7 shows an example of setting the SNOOZE status output function in SNOOZE mode, and Figure 3-8 shows a timing chart.

The example below shows the SNOOZE mode status output combined with A/D converter.

![Block Diagram of SNOOZE Status Output](image-url)
START

Disables interrupt

Processing before transition to STOP mode

A/D converter setting

STOP instruction

Execute A/D conversion

Interrupt request (INTAD)?

Yes (ADIF=1)

No

A/D result = wakeup condition?

Yes

Stop A/D conversion

Stop timer RDe counting after clock setting (f_{CLK} = f_{IH})

Clock setting (f_{CLK} = f_{IH})

END

STOP

EI()

Execute A/D conversion by software trigger.

Remarks: This example is a setting for using the timer RDe interrupt request to release STOP mode and executing A/D conversion. The A/D conversion result is determined by software, and the normal operation mode is entered. Port-related registers are not set in this figure. Please set according to the conditions of use.

- ADIF: A bit in the interrupt request flag register (IF1H)
- f_{IH}: High-speed on-chip oscillator clock frequency
- f_{SL}: Subsystem/low-speed on-chip oscillator select clock frequency

Figure 3-7. Example for SNOOZE Mode Setting (SNOOZE Status Output)
Figure 3-8. Timing Example of SNOOZE Status Output and A/D Conversion

(A) : TRDGRA0 = SNOOZE status output interval
(B) : TRDGRB0 = CPU interrupt delay time
(C) : TRDGRC0 = SNZOUT H pulse width time
3.2 Notes on SNOOZE Mode

- To use UART communication in SNOOZE mode, set the UWC bit in LUSCn register to 1 before executing the STOP instruction. To make the MCU transition to normal operation mode, set the value of the UWC bit to 0. In the following conditions, when the UWC bit is set to 1, data reception may not be performed properly (a framing error or parity error could occur):
  - After setting UWC to 1, data reception has started before the MCU transitions to STOP mode.
  - Data reception has started while another SNOOZE mode function is being executed.
  - After the MCU returns to normal operation mode from STOP mode, data reception has started before setting the UWC bit to 0.

- SNOOZE/STOP modes are released when a reset signal is generated.

- Whether to make the watchdog timer-dedicated low-speed on-chip oscillator continue oscillating or stop oscillating in SNOOZE mode is selected by setting the user option byte (000C0H/040C0H).

- The MCU transitions to SNOOZE mode from STOP mode. For the notes on STOP mode, refer to “2.2 Notes on STOP Mode”.
4. References

Documents referenced in this application note are shown below. When referring to these documents, make sure to obtain the latest version of each document from Renesas Electronics website.

- RL78/ F23, F24 User's Manual: Hardware Rev. 1.00
- RL78 Family User's Manual: Software Rev. 2.30
## Revision History

<table>
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<th>Rev.</th>
<th>Date</th>
<th>Description</th>
<th>Summary</th>
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<tr>
<td>1.00</td>
<td>2022.09.30</td>
<td>-</td>
<td>First edition issued.</td>
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General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)
   A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on
   The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state
   Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins
   Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals
   After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin
   Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between \( V_{IL} \) (Max.) and \( V_{IH} \) (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between \( V_{IL} \) (Max.) and \( V_{IH} \) (Min.).

7. Prohibition of access to reserved addresses
   Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products
   Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.
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